

1 13. (new) The hard sintered body indexable insert as recited in  
2 Claim 1, wherein the hard sintered body is bonded directly  
3 to the tool substrate through the bonding layer.

B 1 14. (new) The hard sintered body indexable insert as recited in  
2 Claim 1, wherein the bonding layer contains 20 wt % to 30  
3 wt % Ti and 20 wt % to 30 wt % Zr, and the remainder of Cu  
4 and inevitable impurities.

1 15. (new) The hard sintered body indexable insert as recited in  
2 Claim 1, wherein the bonding layer contains 0.5 wt % to 20  
3 wt % Ti and/or Zr and contains 10 wt % to 40 wt % Cu and  
4 the remainder of Ag and inevitable impurities.

1 16. (new) The hard sintered body indexable insert as recited in  
2 Claim 1, wherein the bonding layer contains 0.5 wt % to 10  
3 wt % Ti and/or Zr, and contains 5 wt % to 20 wt % In and 15  
4 wt % to 35 wt % Cu, and the remainder of Ag and inevitable  
5 impurities.

1 17. (new) The hard sintered body indexable insert as recited in  
2 Claim 1, wherein on a surface of the hard sintered body  
3 indexable insert, there is formed a coating layer  
4 comprising at least one element selected from the group  
5 consisting of elements belonging to groups IVa, Va, VIa in  
6 the periodic table and elements Al, Si, and B, or at least  
7 one compound selected from the group consisting of nitride,  
8 carbide, or oxide of at least one metal selected from this  
9 group, and their solid solutions.